



**PATENT**  
Atty. Dkt. No. AMAT/6089.P1/CMP/ECP/RKK

3. The Application of:  
Kholodenko

Serial No.: 10/061,126

Confirmation No.: 2260

Filed: January 30, 2002

For: Method and Apparatus for Encapsulation of an Edge of a Substrate During an Electrochemical Deposition process

**MAIL STOP AF**  
**Commissioner for Patents**  
**P.O. Box 1450**  
**Alexandria, VA 22313-1450**

**CERTIFICATE OF MAILING**  
37 CFR 1.8

I hereby certify that this correspondence is being deposited on December 23, 2003 with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

12/23/03      [Signature]  
Date                      Signature

Dear Sir:

**RESPONSE TO OFFICE ACTION DATED SEPTEMBER 25, 2003**

In response to the Office Action dated September 25, 2003, having a shortened statutory period for response set to expire on December 29, 2003, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicants believe that no fee is due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/AMAT/6089.P1/LYC, for any fees, including the fee of \$110.00 for a terminal disclaimer, extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the claims are reflected in the listing of claims which begins on page 2 of this paper. Remarks/Arguments begin on page 5 of this paper.